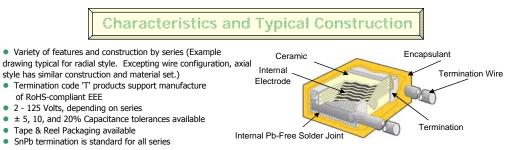
KEMET Through-Hole Ceramic

Revision F, 02 May 2007

Note: Information subject to change without notice. Monitor website regularly for updates. KEMET is not liable for any damages, direct or indirect, consequential or otherwise, that the reader might incur as a result of ignoring this warning, or that any third party might suffer

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RoHS Restricted Substance Content

Key for Determining Adherence to China RoHS and EU 2002/95/EC and 2005/618/EC Content Criteria¹ $O = \leq MCV, X = > MCV, X = > MCV,$ but EU RoHS Compliant with Exemption(s)

Military, Hi-Rel, and their KEMET Part Number equivalents are expressly omitted. Table below represents commercial offerings <u>only</u> .											
			Restricted Material						Compliant Version		
		Material and MCV ¹	Cd	Cr ⁶⁺	Pb	Hg	PBB	PBDE	Available	Standard	China RoHS
KEMET Product	Series	Termination Code	< 0.01%	< 0.1%	< 0.1%	< 0.1%	< 0.1%	< 0.1%	since since	Symbol ³	
Golden Max Conformally Coated Radial, Standard and High Voltage Aximax Conformally Coated Axial	C3xx C4xx	т, с	0	0	X²	0	0	0	C346 (0.025 dia wire), C350, C356 = Apr-05 All others = Nov-04	T = unique for Pb- Free, for C code, same dates as availability apply.	
Golden Max Conformally Coated Radial, Standard and High Voltage Aximax Conformally Coated Axial	C3xx C4xx	н	Ο	0	X	0	0	0			
High Voltage Golden Max	C6xx	Т	0	0	X ²	0	0	0	Nov-06	Nov-06	60
Commercial Molded Radial	C052, C062, C512, C522	С	0	0	Х	0	0	0			-
	C052, C062	Т	ο	0	X ²	0	0	0	Nov-06	Nov-06	
Commercial Molded Axial	C114, C124, C192, C202, C222	С	0	0	X	0	0	0			

¹MCV = Maximum Concentration Values per 2005/618/EC amending RoHS Directive 2002/95/EC and China RoHS criteria.

²Commercial grade (non-automotive, non-Military) C3xx manufactured since 15Jan06 and C4xx manufactured since 01May06 contain lead-free internal attachment solder. All others rely on RoHS Directive Annex 1 exemption 7a for compliance due to the high lead content (>85% Pb) internal solder joint. Some values also rely on exemptions 5 and 7a for compliance. China RoHS Symbol based on current manufacturing. Refer to notes in Pb column for transition dates.

Soldering Capability Characteristics

	100% Matte Tin Termination	SnPb Termination		
Termination Material	Steel Nickel	Copper Clad Steel		
Termination Plating (Barrier)	100% Matte Tin (Nickel)	60Sn40Pb Golden Max, 70Sn30Pb Aximax		
Peak Temperature Capability	260°C	260°C		
Soldering Process Compatibility	Backward & Forward Compatible	Backward & Forward Compatible		
MSL Rating	Not Classified ⁴	Not Classified ⁴		
Tin Whisker Test Results per JESD22-A121 and JESD201 ⁵	Class 2 ⁵	Class 2 ⁵		

MSL not classified for through-hole style capacitors. J-STD-020 is applicable to non-hermetic surface mount devices. If an MSL were required, this product family would be considered MSL 1 or better.

Tin whiskering is not considered a reliability risk within the capacitor industry for non-Military / Hi-Rel applications. For more information, refer to EIA/ECA component bulletin CB19.

Note: Refer to the online KEMET product catalog for part Ordering Identification numbering of MIL-PRF- and KEMET Military equivalents. <u>C 320 C</u> <u>102 M 1 R 5 T</u> A Reel level KEMET EZ ID label indicates CERAMIC product content relative to substance restrictions Failure Rate Level SERIES of the EU RoHS Directive, 2002/95/EC, 2005/618/EC and A = Not Applicable See available offerings China RoHS.. listed above RoHS-PRC = Meets criteria without exemption INTERNAL CONSTRUCTION RoHS-EU = Meets criteria with exemption SPECIFICATION C = Standa RoHS-NO = Does not meet criteria Termination Code for CAPACITANCE CODE 0. # 1068144/170 31433 DATE CODE 030707FF MIL P/N MILD END METALIZATION NTITY 1000 #85100 WIT FI P/N C0402C103K4RAC76537867 010LF VOLTS 16 770652010 CAPACITANCE TOLERANCE T = 100% Matte Sn (Sn) M = ±20%, K = ±10%, J = ±5% H = Tin/Lead (SnPb, 5% min. Pb) KEMET Use of C Code varies by product line: RATED VOLTAGE DIELECTRIC •C3xx, C4xx = Not recommended for new design

•Commercial Molded Axial & Radial Products = Tin/Lead (SnPb, 5% min. Pb)

